

Part Number: XZCBD45W30MAV-6

 $3.5~\mathrm{x}2.8\mathrm{mm}$ SMD CHIP LED LAMP

Features

 \bullet Ideal for indication light on hand held products

• Long life and robust package

• Variety of lens types and color choices available

• Package: 500pcs / reel

• Moisture sensitivity level : level 3

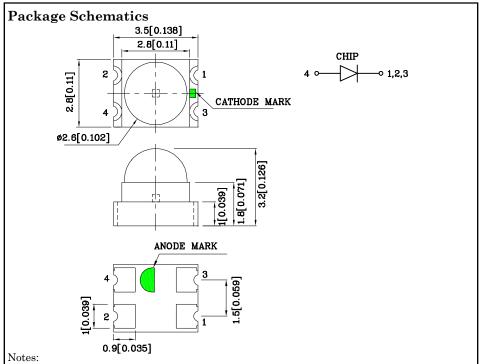
• RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	CBD (InGaN)	Unit		
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	P_{D}	126	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	C	
Electrostatic Discharge Threshold (HBM)		250	V	

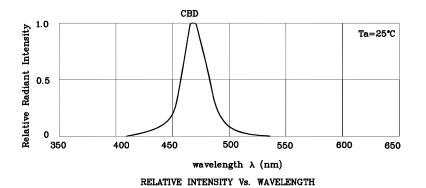
Operating Characteristics (T _A =25°C)		CBD (InGaN)	Unit
Forward Voltage (Typ.) (I _F =30mA)	V_{F}	3.5	V
Forward Voltage (Max.) (I _F =30mA)	V_{F}	4.2	V
Reverse Current (Max.) $(V_R=5V)$	${ m I}_{ m R}$	50	uA
Wavelength of Peak Emission (Typ.) (I _F =30mA)	λΡ	468	nm
Wavelength of Dominant Emission (Typ.) (I _F =30mA)	$\lambda \mathrm{D}$	470	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =30mA)	$\triangle \lambda$	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	рF

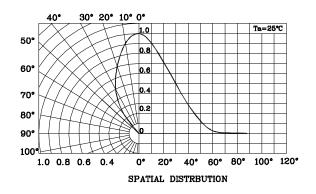
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =30mA) mcd		Wavelength nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZCBD45W30MAV-6	Blue	InGaN	Water Clear	280	547	468	60°

Apr 22,2011 XDSB4692 V2 Layout: Maggie L.

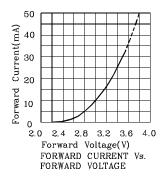


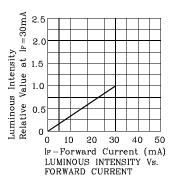


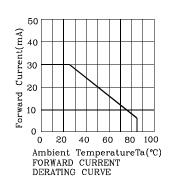


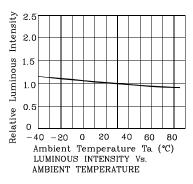


❖ CBD



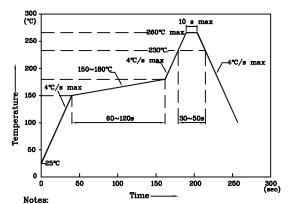






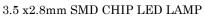
LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



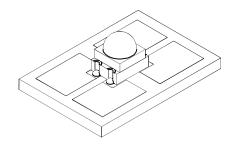
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



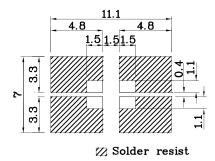


❖ The device has a single mounting surface. The device must be mounted according to the specifications.

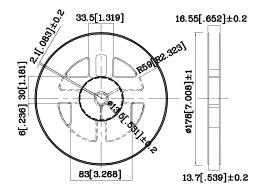
www.SunLEDusa.com



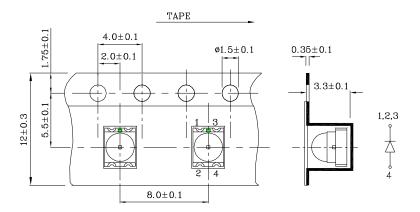
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

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- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

XDSB4692 V2 Layout: Maggie L.





PACKING & LABEL SPECIFICATIONS

